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Nation of Allowskiller	Application No.	Applicant(s)	
	10/666,775	BIGGS ET AL.	
Notice of Allowability	Examiner	Art Unit	
	Thanhha Pham	2813	
The MAILING DATE of this communication appeal claims being allowable, PROSECUTION ON THE MERITS IS herewith (or previously mailed), a Notice of Allowance (PTOL-85) NOTICE OF ALLOWABILITY IS NOT A GRANT OF PATENT RIOF the Office or upon petition by the applicant. See 37 CFR 1.313	(OR REMAINS) CLOSED in this app or other appropriate communication GHTS. This application is subject to	olication. If not includ will be mailed in due	ed course. <b>THIS</b>
1. 🔀 This communication is responsive to 09/08/05 & interview	<u>dated 10/25/05</u> .		
2. ☑ The allowed claim(s) is/are <u>16,17 and 19</u> .			
3.  ☐ Acknowledgment is made of a claim for foreign priority unexpected by the priority documents have a comment of the certified copies of the priority documents have a copies of the priority documents have a copies of the certified copies of the priority documents have a copies of the certified copies of the priority documents have a copies of the certified copies of the priority documents have a copies of the certified copies of the priority documents have a copies of the certified copies of the priority documents have a copies of the priority documents ha	e been received.  been received in Application No cuments have been received in this is of this communication to file a reply of this application.  itted. Note the attached EXAMINER' ces reason(s) why the oath or declarated be submitted. Son's Patent Drawing Review (PTO- ces Amendment / Comment or in the Ces cases.  34(c)) should be written on the drawing he header according to 37 CFR 1.121(ces).	complying with the rest of S AMENDMENT or Nation is deficient.  948) attached office action of the last of the front (not the last).	quirements
Attachment(s)  1. ☑ Notice of References Cited (PTO-892)  2. ☐ Notice of Draftperson's Patent Drawing Review (PTO-948)  3. ☐ Information Disclosure Statements (PTO-1449 or PTO/SB/0 Paper No./Mail Date  4. ☐ Examiner's Comment Regarding Requirement for Deposit of Biological Material	5. ☐ Notice of Informal P 6. ☑ Interview Summary Paper No./Mail Dat 7. ☑ Examiner's Amendn 8. ☑ Examiner's Stateme 9. ☐ Other	(PTO-413), te <u>10/25/2005</u> . nent/Comment	·

## **EXAMINER'S AMENDMENT**

1. An examiner's amendment to the record appears below. Should the changes and/or additions be unacceptable to applicant, an amendment may be filed as provided by 37 CFR 1.312. To ensure consideration of such an amendment, it MUST be submitted no later than the payment of the issue fee.

Authorization for this examiner's amendment was given in a telephone interview with William Hogg on 10/25/2005.

The application has been amended as follows:

In claim 16,

line 7, change "a conductive seed layer " to – an intermediate conductive layer of TaN/Ta –

lines 8-9, change "having at least one exposed edge" to – a top surface of said layer of dielectric material –

between lines 9-10, insert – a conductive seed layer disposed in said opening, overlying said intermediate conductive layer and in contact therewith and overlying said top surface of said layer of dielectric material, said conductive seed layer having exposed edges; and --

line 10, change "at least one of layer of said conductive material" to – two layers of Ni and Au plated on said conductive seed layer in said opening, --

line 11, after "all exposed edges" insert --, said two layers of Ni and Au define walls in said opening in which a ball bond and wire is wholly disposed –

line 11, change ";" to -- . --

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lines 12-14, delete "two layers of Ni and Au plated on said conductive seed layer in said opening wherein an intermediate conductive layer of TaN/Ta is provided between said conductive seed layer and said conductive bond pad"

• • Cancel claim 18

## Allowable Subject Matter

- 1. Claims 16-17 and 19 are allowed.
- 2. The following is an examiner's statement of reasons for allowance: Recorded Prior Art fails to disclose or suggest the combination of structure of an I/C chip suitable for wire bonding as recited in claim 16 including: a conductive seed layer disposed in said opening, overlying said intermediate conductive layer and in contact therewith and overlying said top surface of said layer of dielectric material, said conductive seed layer having exposed edges; and two layers of Ni and Au plated on said conductive seed in said opening, overlying said conductive seed layer and completely covering said conductive seed layer including all exposed edges, said two layers of Ni and Au define walls in said opening in which a ball bond and wire is wholly disposed.
- 3. Any comments considered necessary by applicant must be submitted no later than the payment of the issue fee and, to avoid processing delays, should preferably accompany the issue fee. Such submissions should be clearly labeled "Comments on Statement of Reasons for Allowance."
- 4. Any inquiry concerning this communication or earlier communications from the examiner should be directed to Thanhha Pham whose telephone number is (571) 272-

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1696. The examiner can normally be reached on Monday and Thursday 9:00AM - 9:30PM.

If attempts to reach the examiner by telephone are unsuccessful, the examiner's supervisor, Carl Whitehead can be reached on (571) 272-1702. The fax phone number for the organization where this application or proceeding is assigned is 571-273-8300.

Information regarding the status of an application may be obtained from the Patent Application Information Retrieval (PAIR) system. Status information for published applications may be obtained from either Private PAIR or Public PAIR. Status information for unpublished applications is available through Private PAIR only. For more information about the PAIR system, see http://pair-direct.uspto.gov. Should you have questions on access to the Private PAIR system, contact the Electronic

Business Center (EBC) at 866-217-9197 (toll-free).

Thanhha Pham Patent Examiner